

New India Opportunities for Semiconductor Manufacturing

May 2024



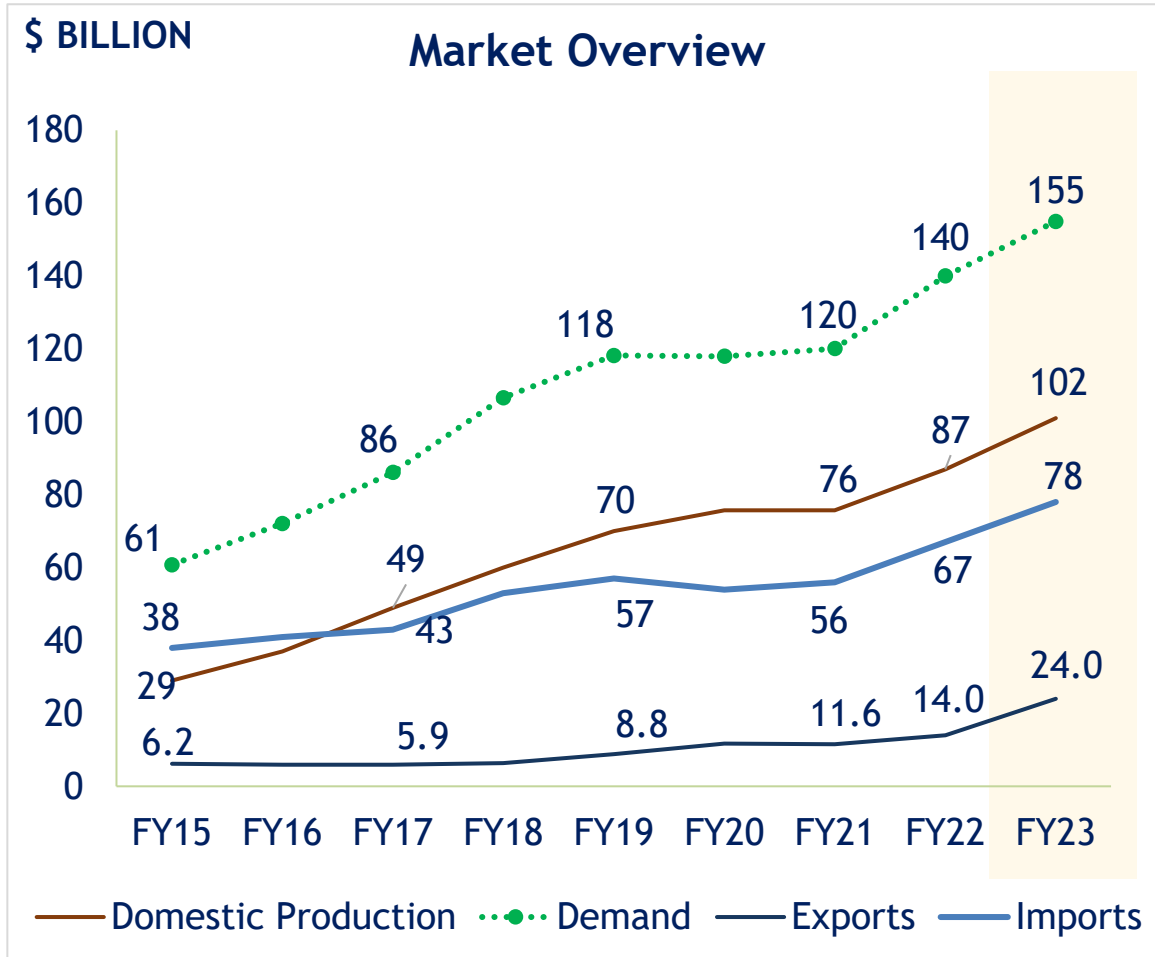
INVEST INDIA

ESDM Market Overview

Globally Competitive Ecosystem

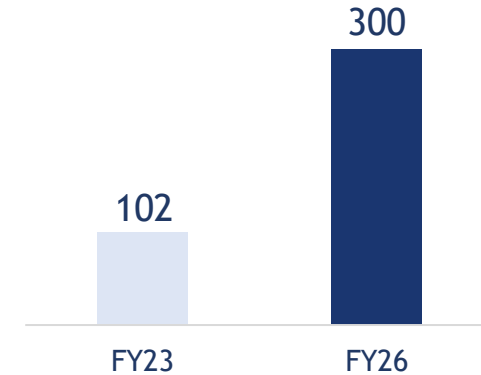
\$300 Bn Electronics Manufacturing by 2026

Exports of \$120 Bn by FY26

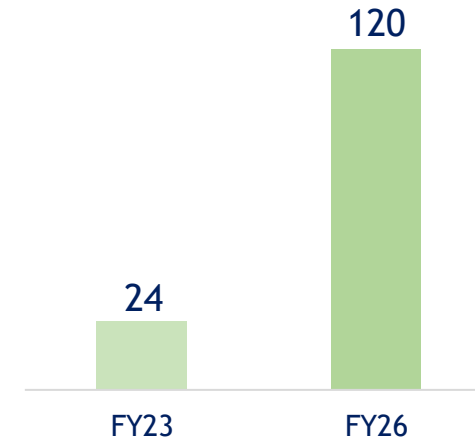


Source: Ministry of Electronics and IT Annual Report

Electronics Production (\$ Bn)



Export of Electronics Goods (\$ Bn)



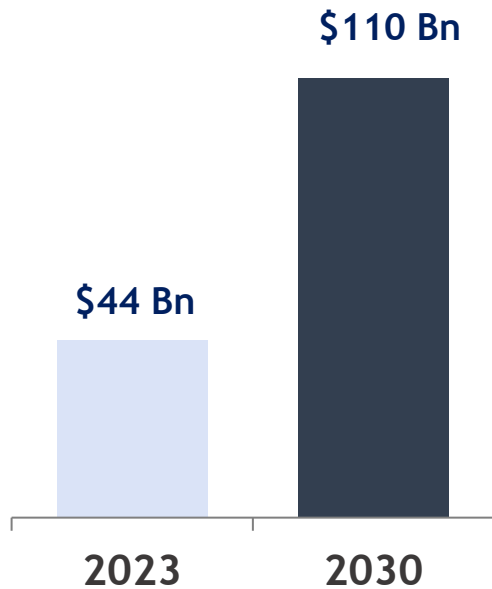
3.75 % India's share in global electronics manufacturing in FY22

US\$110 Bn Semiconductor Market Opportunity by 2030

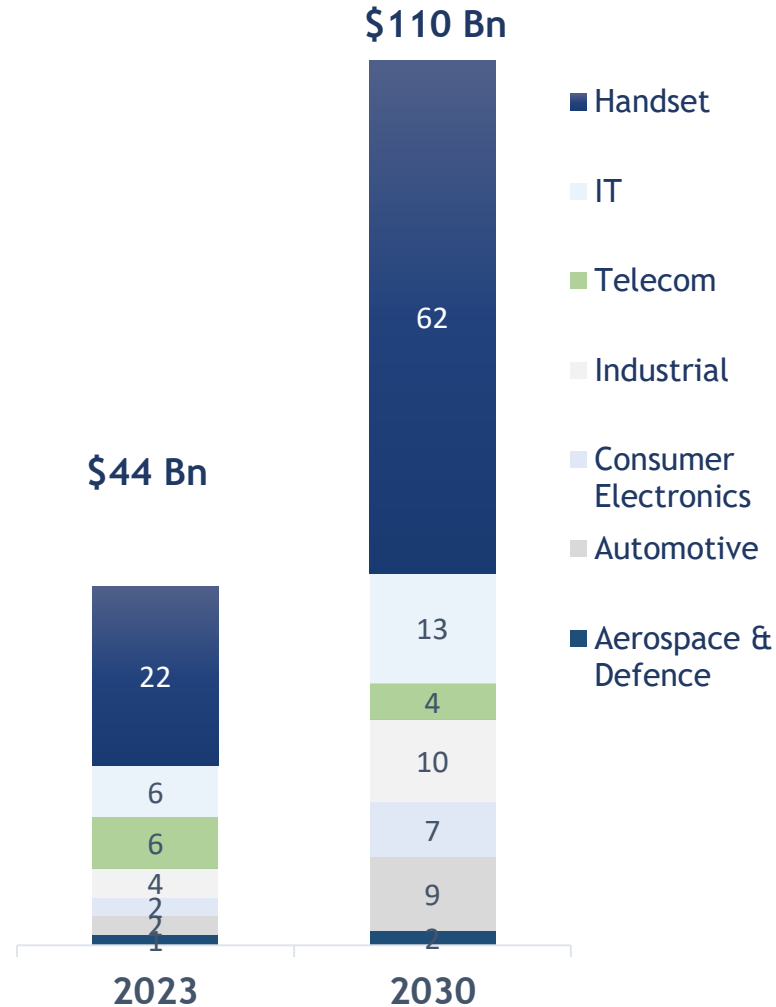
India as next engine of market growth

Semiconductor Market

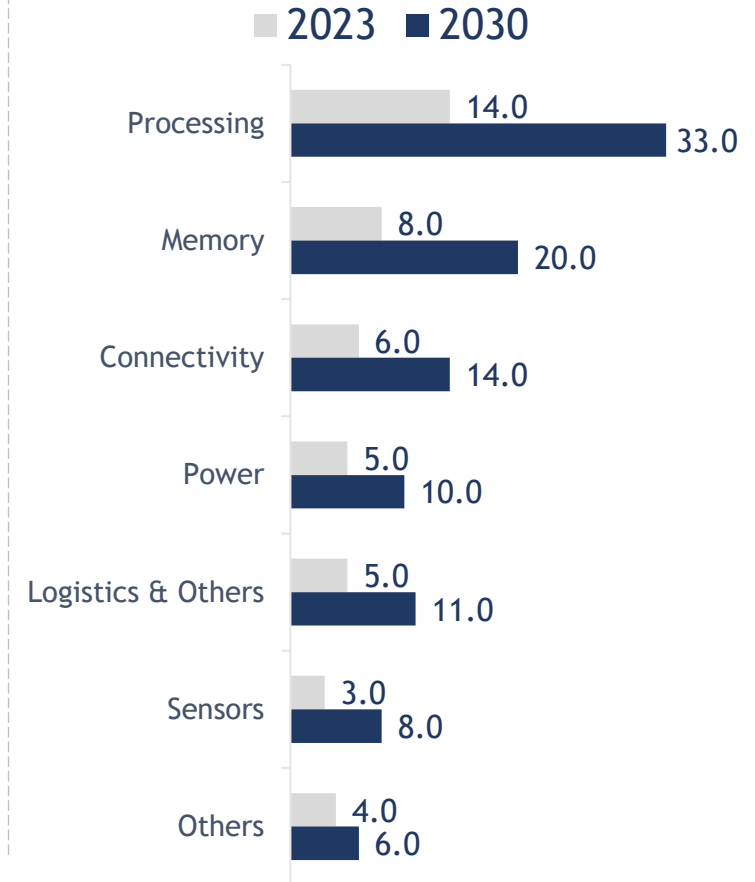
~10% of Global by 2030



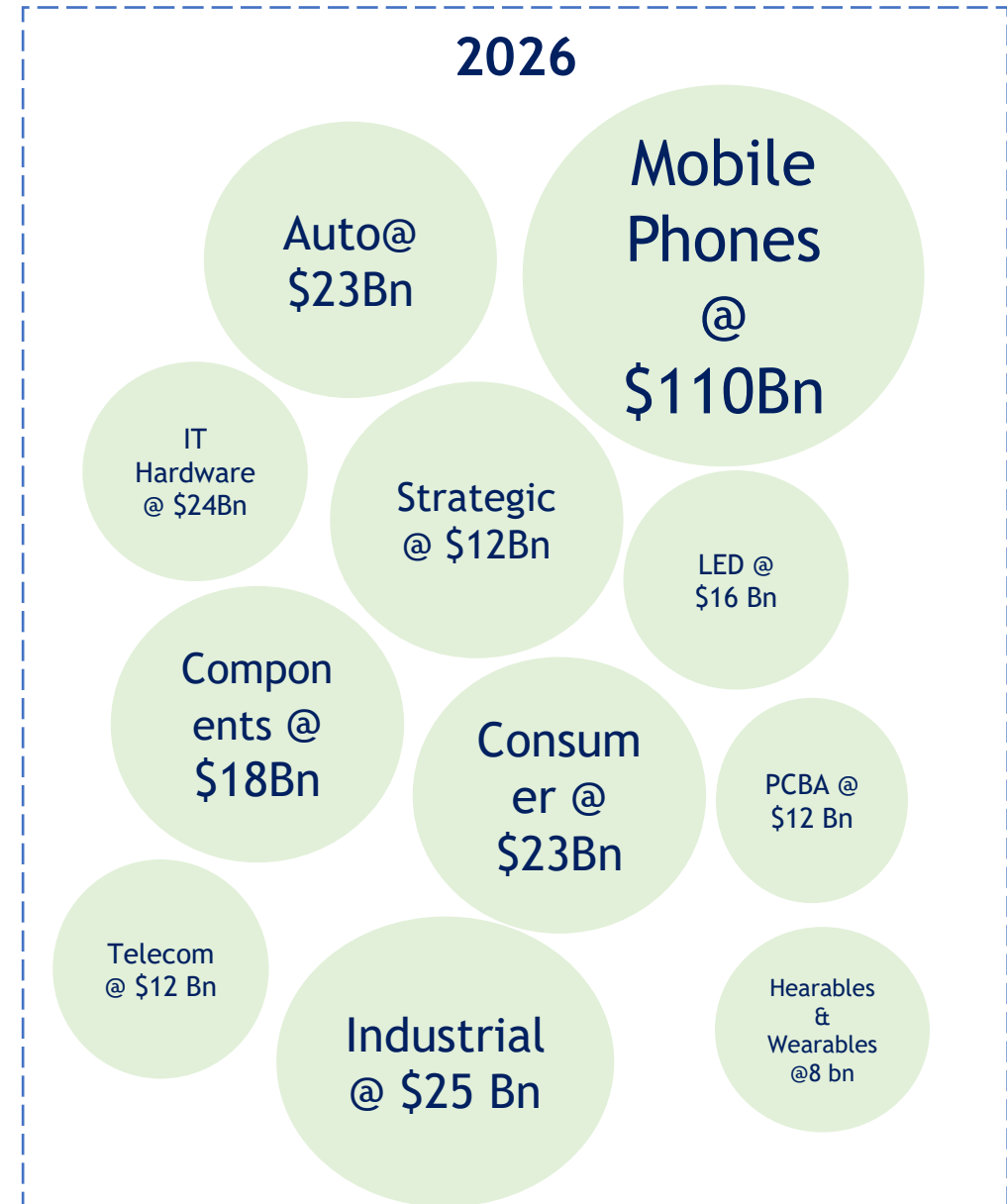
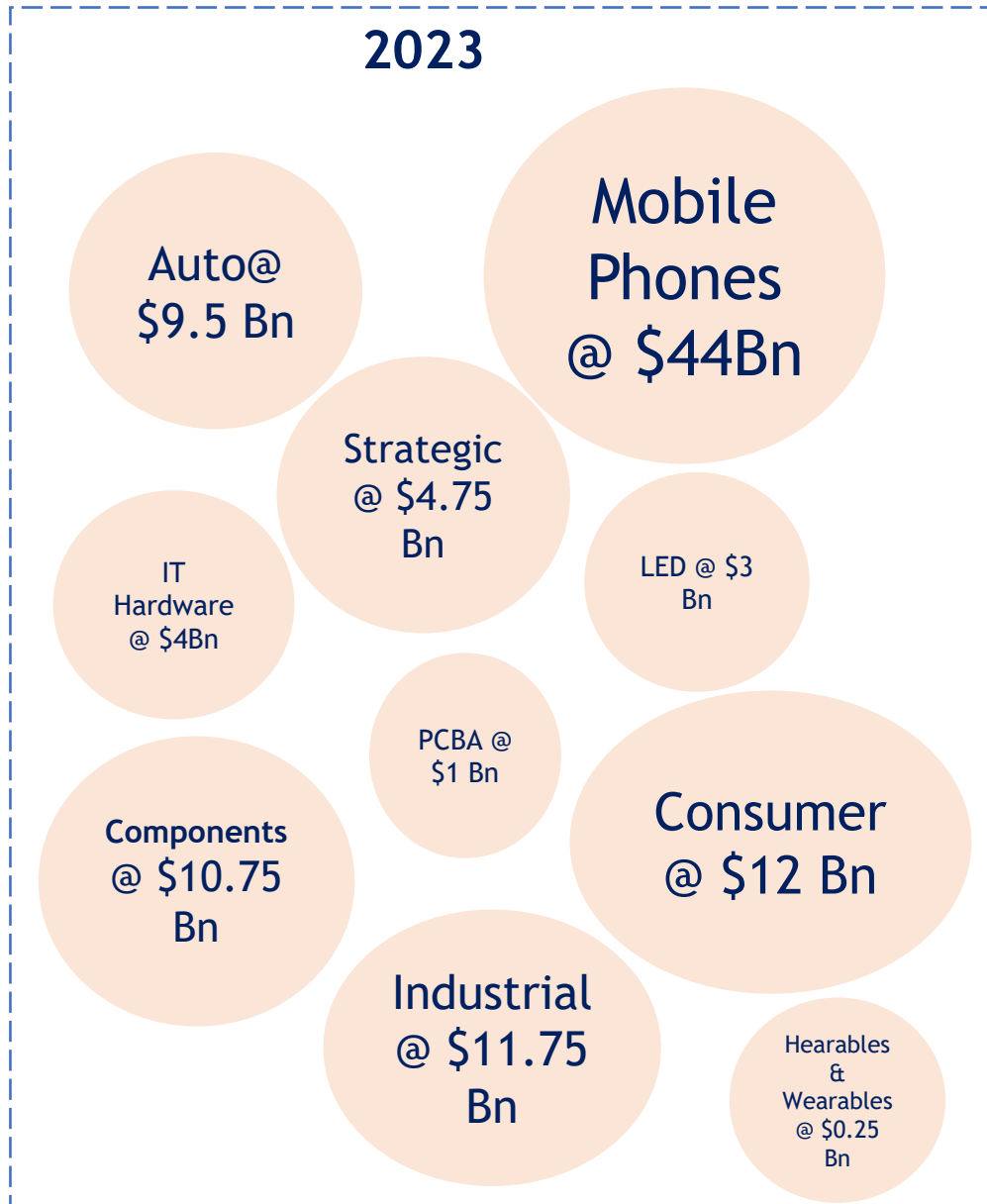
Market by Application (\$ Bn)



Market By Component (\$ Bn)



India in 2026: Roadmap for \$300 Bn Electronics Manufacturing



Growing Electronics Landscape

Key Clusters / Hubs

1. Uttar Pradesh - Noida, Greater Noida
2. Haryana - Gurgaon, Manesar
3. Tamil Nadu - Sriperumbudur
4. Andhra Pradesh - Sri City, Kadapa
5. Maharashtra - Pune
6. Karnataka - Bangalore, Mysore
7. Telangana - Hyderabad
8. Gujarat - Dholera / Sanand



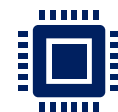
*Latest State GDPs indicated in brackets

India's Success Stories for Semiconductors (1/2)

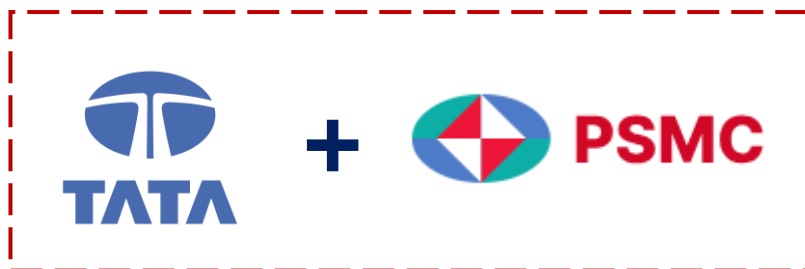
India's First Semiconductor Foundry



Project Cost: **\$11 Bn**; Capacity: 50,000 wspm
Location: Dholera, Gujarat



- High performance compute chips (28 nm)
- Power Management Chips (EV, Defence, Telecom, etc)
- *First chip roll out by 2026*

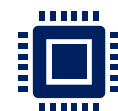


Semiconductor Assembly & Test

Large Scale ATMP Development



Project Cost: **\$3 Bn**; Capacity: 48 million / day
Location: Morigaon, Assam



Packaged chips for Automotive & EV, consumer electronics, telecom, mobile phones, etc

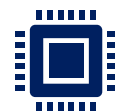
India's Success Stories for Semiconductors (2/2)



Packaging Partnerships with Japan & Thailand



Project Cost: **\$950 Mn**; Capacity: 15 million / day
Location: Sanand, Gujarat



Packaging chips for consumer, industrial, automotive and power applications

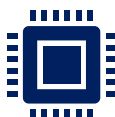
Memory ATMP Ecosystem Creation



Project Cost: **\$2.75 Bn**; Location: Sanand, Gujarat
*Incentives worth **\$1.9 Bn (70%)** from Centre & State Governments*



Global Record: Construction Commenced in 90 days
Project announced in Jun'23



- Assembly and test for DRAM and NAND flash
- *First Chip roll out by Dec'24*

\$800+ Mn in Semiconductor R&D Investments



Committed **\$400 Mn** for a Collaborative Engineering Center in Karnataka.
Faster innovation in equipment design & prototyping with global supply chain partners



Creating virtual nano fabrication environment in India to train up to **60,000 semicon engineers** for both Indian and global workforce requirements.



A marquee fabless company, investing **\$400 Mn** to setup a new design center for R&D and engineering in Karnataka, India.

Policy & Incentives

Making India a Global Hub for Electronics Manufacturing



\$30+ Bn in Fiscal Support

\$10 Bn

Support for Semiconductor and Display Ecosystem

1. Semiconductor Fabs and Display Fabs
2. Compound Semiconductor and ATMP
3. Design Linked Incentive (DLI)
4. Modernization of Semiconductor Laboratory (SCL)

\$8 Bn

Support for Electronics Manufacturing

1. Production Linked Incentives for Mobile Phones, Components, IT Hardware
2. Capex Linked Incentives for components, sub-assemblies
3. Development of Electronics Manufacturing Clusters

\$13 Bn

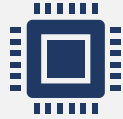
Support for Allied Sectors

Production Linked Incentives for

1. Advanced Chemistry Cell
2. Automobiles & Auto Components
3. Telecom & Networking
4. Solar PV Modules
5. White Goods
6. Medical Devices

Modified Semicon India Program

Outlay Approved: USD 10.20 Bn across four verticals



Semiconductor fabs

- **Fiscal Support: 50% of project cost on pari-passu basis**
- **Technologies covered:** All node sizes for Silicon CMOS based fabs



Display fabs

- **Fiscal Support: 50% of project cost on pari-passu basis**
- **Technologies covered:** New gen TFT LCD & AMOLED displays



Compound Semiconductor & Packaging

- **Fiscal Support: 50% of Capex pari-passu basis**
- **Technologies covered:** OSAT/ATMP, Compound Semiconductor, Silicon Photonics, Sensors (including MEMS)



Semiconductor Design

- **Product Design Linked Incentive: 50% of Eligible expenditure**
- **Deployment Linked Incentive: 6% - 4% on Net Sales**
- **Design Infrastructure Support**

* For domestic companies, startups & MSMEs

- **2.5% of the outlay** of these schemes have been earmarked for R&D, skill development, and training
- Custom duty exemption on Capital goods, Machinery, Electrical Equipment, other instruments and their parts for manufacturing

Fiscal Support for Semiconductor Packaging (ATMP / OSAT) & Compound Semiconductors

50%

Fiscal Support

(% of Capex on pari passu basis)



- **Target segment** includes OSAT, compound semiconductors, silicon photonics, sensors (including MEMS), discrete semiconductors
- **Eligibility:** Min cap investment of ~\$ 13 Mn for compound semi and ~\$6.5 Mn for OSAT facilities; Wafer size of 150/200 mm or more and wspm of 500 or more for compound semi
- Eligible Capex will include building, clean rooms, plant & machinery (including used / second hand); transfer of technology and R&D. **Capex does not include cost of land.**
- **Policy tenure:** 5 years
- **Application Window ends on 31st December 2024**

50%

Fiscal Support

(% of Project Cost on pari passu basis)



- For all process nodes with 300 mm wafer size and installed capacity of 40k wspm
- **Eligibility:** Min capital investment of ~\$ 3 Bn; min ESDM revenue of ~\$ 1 Bn
- **Policy tenure:** Six years

Fiscal Support for Display Fabs

50%

Fiscal Support

(% of Project Cost on pari passu basis)

Eligibility Thresholds

~\$1.3B

Minimum Capital Investment

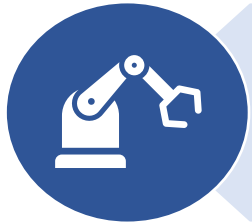
~\$1B

Minimum Revenue

	TFT LCD	AMOLED
Technology	Generation 8 or above	Generation 6 or above
Installed Capacity (in panels / month)	60k or more	30k or more

Project cost is inclusive of land cost

Additional State Incentives for setting up manufacturing bases



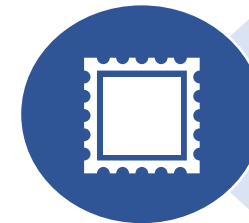
15-20% Capital Subsidy
for plant, machinery
import



100% Electricity Duty
Exemption
Power Tariff Subsidy
@INR 1



25-50% Land Rebate &
Subsidy on Land Lease



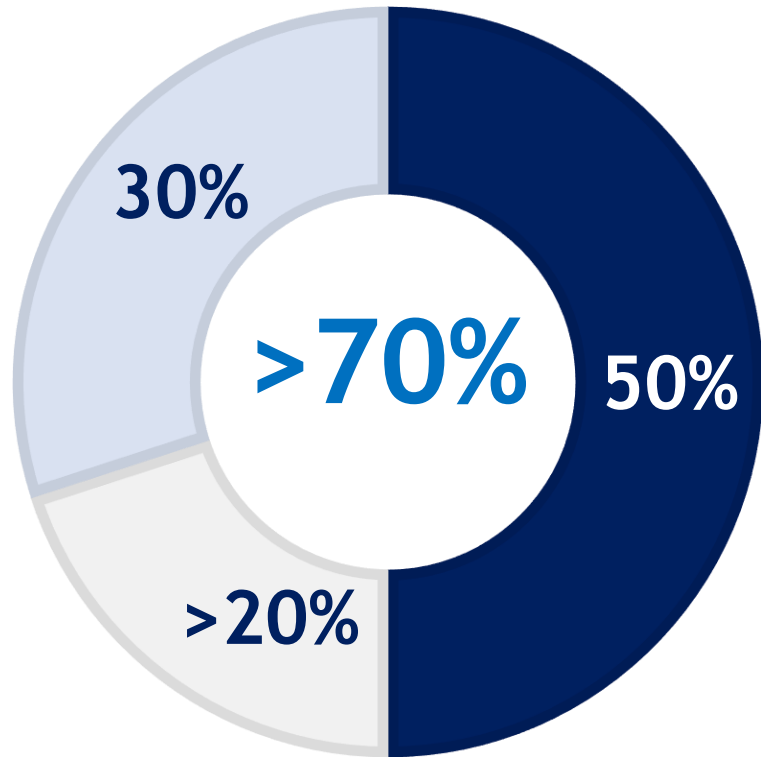
100% Exemption on
Stamp Duty &
Conversion Fee



Tax Exemption:
100% SGST
Reimbursement

Customised Packages available for Mega Investments

70% Project Cost as Incentives for Semicon Manufacturing



■ Govt. of India (Pari passu) ■ State Govt. ■ Applicant

Target Segments

- Semiconductor Fab (all nodes)
- Display Fab (LCDs/AMOLED)
- ATMP/OSAT
- Compound Semiconductors Fab
- MEMS
- Sensors
- Discrete devices

Enhancing Partnerships for Building Resilient Supply Chains



Cooperation on Semiconductor Development

10th India-RoK Joint Commission Meeting

External Affairs Minister of India, Dr. S. Jaishankar, and South Korea's Foreign Affairs Minister, Mr. Cho Tae-yul, pledged to expand bilateral & international cooperation in critical technologies, semiconductors, and supply chain resilience.

Inaugural Trilateral Technology Meeting between South Korea, USA, and India

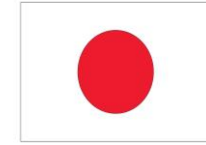
Explored collaborative prospects in IT & Electronics with a focus on semiconductor supply chains.



iCET - Initiative on Critical & Emerging Technology

Signed by National Security Council Secretariat, India and U.S. National Security Council

- **Semiconductors:**
 - Enhance bilateral collaboration on supply chains
 - Support development of design, manufacturing and fab ecosystem in India
 - Development of skilled workforce to cater to global talent requirements
- **Task Force** created for **STEM education partnerships**
- Strengthening cooperation and R&D in **AI, Quantum Compute, 5G/6G, Defence**



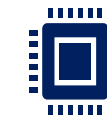
MoC* for Semiconductor Development



Talent & Skill development for design and manufacturing



Enhancing cooperation for equipment, tools, parts and fab consumables (specialty chemicals, materials)



Support for chip fabrication & OSAT



Thank You!